

## 1. Description

BLG40T120FDH is obtained by advanced Trench Field Stop (T-FS) technology which reduces the conduction loss, improve switching performance, and enhance the avalanche energy. The IGBT is suitable device for UPS, Welding, and high-speed switching.

### KEY CHARACTERISTICS

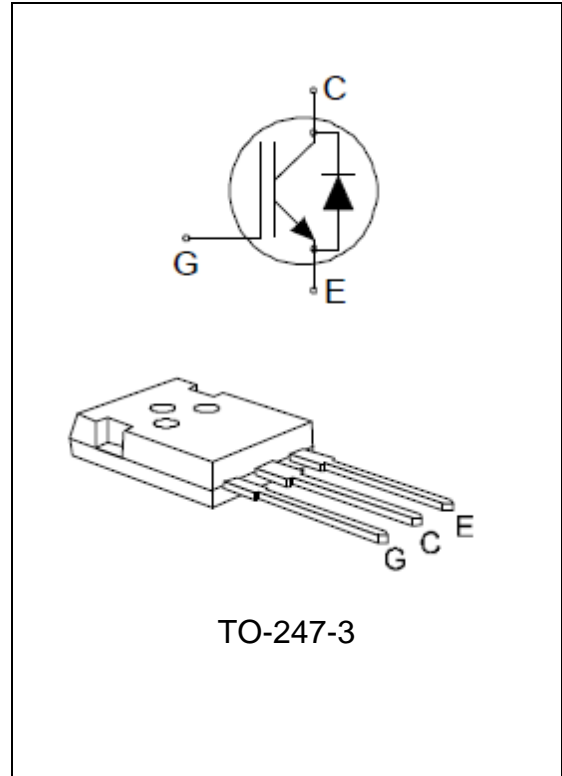
Parameter	Value	Unit
$V_{CES}$	1200	V
$I_C$	40	A
$V_{CE(sat).typ}$	1.9	V
$P_D (T_C=25^\circ C)$	367	W

### FEATURES

- Fast Switching
- Low  $V_{CE(sat)}$
- Positive temperature coefficient
- Very soft, fast recovery anti-parallel diode
- RoHS product

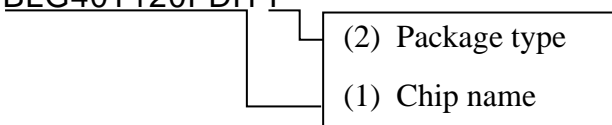
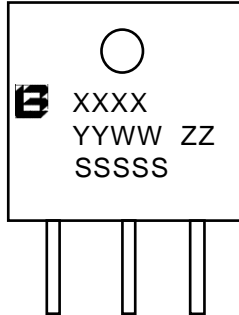
### APPLICATIONS

- UPS
- Welding Converters
- Converters with high switching frequency



## ORDERING INFORMATION

Ordering Codes	Package	Product Code	Packing
BLG40T120FDH-F	TO-247	G40T120FDH	Tube

<p><b>BLG40T120FDH-F</b></p>  <p>(1) BLG40T120FDH:1200V 40A (2) F:TO-247</p>	 <p>XXXX: Product Code YYWW: Year &amp; Week ZZ: Assembly Code SSSS: Lot Code</p>
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## 2. ABSOLUTE RATINGS

at  $T_C = 25^\circ\text{C}$ , unless otherwise specified

Symbol	Parameter	Rating	Units
$V_{CES}$	Collector-Emitter Voltage	1200	V
$I_C$	Collector Current @ $T_C=25^\circ\text{C}$	80	A
	Collector Current @ $T_C=100^\circ\text{C}$	40	A
$I_{CM}$	Pulsed Collector Current (Note1) @ $T_C=25^\circ\text{C}$	160	A
$I_F$	Diode Continuous Forward Current @ $T_C=25^\circ\text{C}$	80	A
	Diode Continuous Forward Current @ $T_C=100^\circ\text{C}$	40	A
$I_{FM}$	Diode Maximum Forward Current @ $T_C=25^\circ\text{C}$	160	A
$V_{GES}$	Gate-Emitter Voltage	$\pm 20$	V
$P_D$	Power Dissipation @ $T_C=25^\circ\text{C}$	367	W
$T_{Jmax}, T_{stg}$	Operating Junction and Storage Temperature Range	150, $-55$ to 150	$^\circ\text{C}$
$T_L$	Maximum Temperature for Soldering	260	$^\circ\text{C}$

## 3. Thermal characteristics

Symbol	Parameter	RATINGS	Units
$R_{\theta JC}$	Junction-to-Case (IGBT)	0.34	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Junction-to-Case (Diode)	0.55	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Junction-to-Ambient	40	$^\circ\text{C}/\text{W}$

## 4. Electrical Characteristics

at  $T_C = 25^\circ\text{C}$ , unless otherwise specified

OFF Characteristics						
Symbol	Parameter	Test Conditions	Values			Units
			Min.	Typ.	Max.	
$V_{CES}$	Collector-Emitter Breakdown Voltage	$V_{GE} = 0\text{V}$ , $I_C = 250\mu\text{A}$	1200	--	--	V
$I_{CES}$	Collector-Emitter Leakage Current	$V_{CE} = 1200\text{V}$ , $V_{GE} = 0\text{V}$	--	--	250	$\mu\text{A}$
$I_{GES(F)}$	Gate-Emitter Leakage Current	$V_{GE} = +20\text{V}$	--	--	600	nA
$I_{GES(R)}$	Gate-Emitter Reverse Leakage	$V_{GE} = -20\text{V}$	--	--	-600	nA

### ON Characteristics

Symbol	Parameter	Test Conditions	Values			Units
			Min.	Typ.	Max.	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE} = 15V$ , $I_C = 40A$	--	1.9	2.4	V
$V_{GE(TH)}$	Gate Threshold Voltage	$V_{CE} = V_{GE}$ , $I_C = 1mA$	5.0	5.8	6.5	V

Pulse width  $t_p \leq 300\mu s$ ,  $\delta \leq 2\%$

### Dynamic Characteristics

Symbol	Parameter	Test Conditions	Values			Units
			Min.	Typ.	Max.	
$C_{iss}$	Input Capacitance	$V_{GE}=0V$ $V_{CE}=25V$ $f = 1.0MHz$	--	3630	--	pF
$C_{oss}$	Output Capacitance		--	180	--	
$C_{rss}$	Reverse Transfer Capacitance		--	90	--	
$Q_g$	Total Gate Charge	$I_C=40A$ , $V_{CE}=960V$ $V_{GE}=15V$		245		nC

### Switching Characteristics

Symbol	Parameter	Test Conditions	Values			Units
			Min.	Typ.	Max.	
$t_{d(ON)}$	Turn-on Delay Time	$I_C = 40A$ $V_{CE} = 600V$ $V_{GE} = 15V$ $R_G = 10\Omega$ $T_J = 25^\circ C$ Inductive Load	--	48	--	ns
$t_r$	Rise Time		--	90	--	
$t_{d(OFF)}$	Turn-Off Delay Time		--	275	--	
$t_f$	Fall Time		--	55	--	
$E_{on}$	Turn-On Switching Loss		--	5.8	--	mJ
$E_{off}$	Turn-Off Switching Loss		--	1.5	--	
$E_{ts}$	Total Switching Loss		--	7.30	--	

### Diode Characteristics

Symbol	Parameter	Test Conditions	Values			Units
			Min.	Typ.	Max.	
$V_F$	Diode Forward Voltage	$I_F=20A$	--	2	2.5	V
$T_{rr}$	Reverse Recovery Time	$I_F=20A$ , $di/dt=200A/\mu s$ , $T_J=25^\circ C$	--	73	--	ns
$Q_{rr}$	Reverse Recovery Charge		--	654	--	nC
$I_{rrm}$	Reverse Recovery Current		--	14.9	--	A

Note1: Pulse width limited by maximum junction temperature

## 5. Characteristics Curves

Figure 1. Forward Bias Safe Operating Area

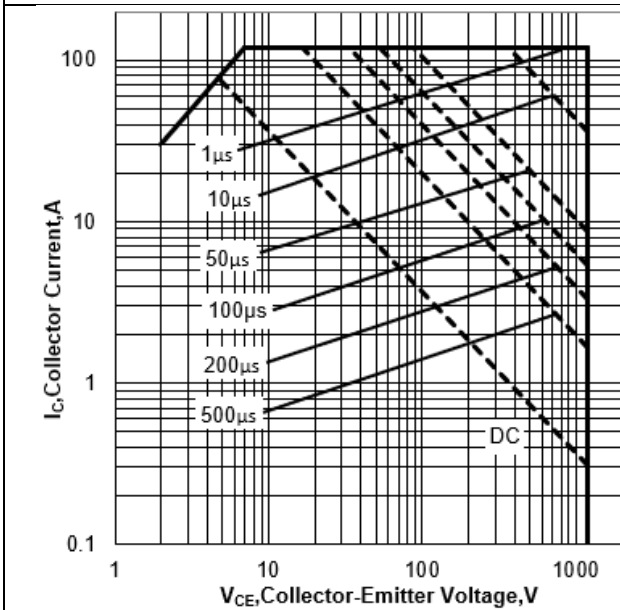


Figure 2. Power Dissipation vs Case Temperature

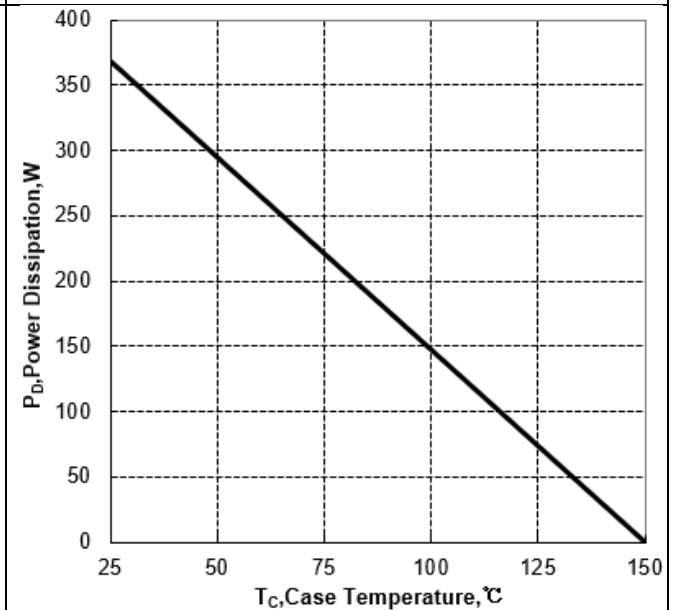


Figure 3. Collector Current vs Case Temperature

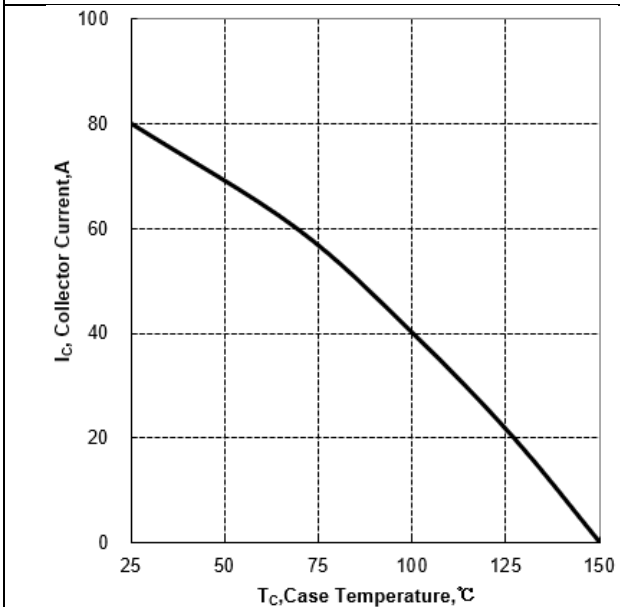


Figure 4. Typical Transfer Characteristics

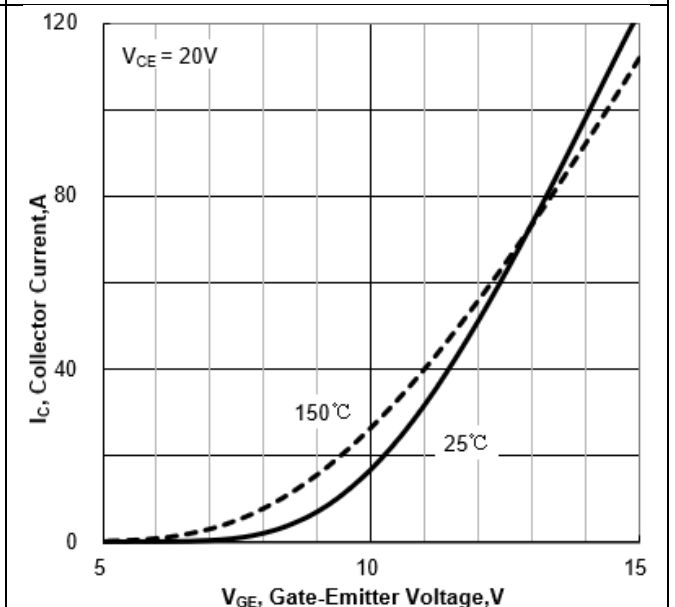


Figure 5. Typical Output Characteristics(T=25°C)

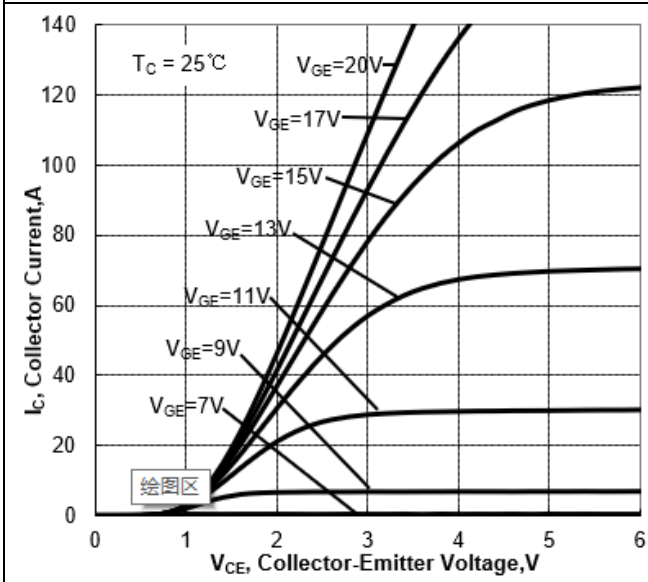


Figure 6. Typical Output Characteristics(T=150°C)

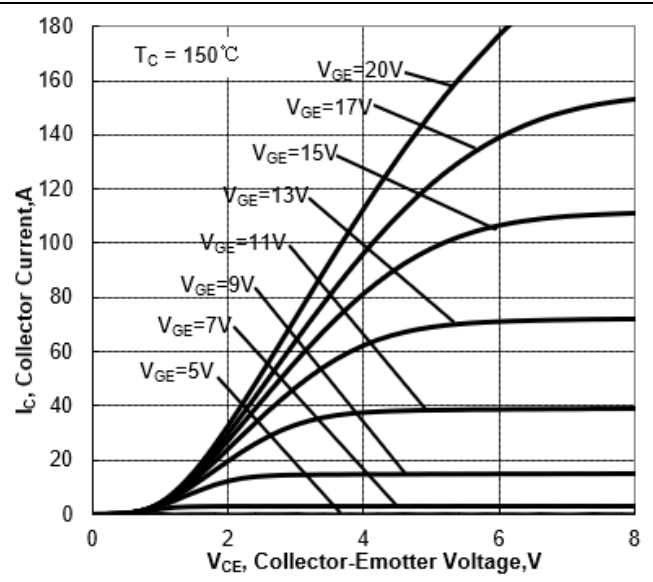


Figure 7. Typical Collector-Emitter Saturation Voltage vs Junction Temperature

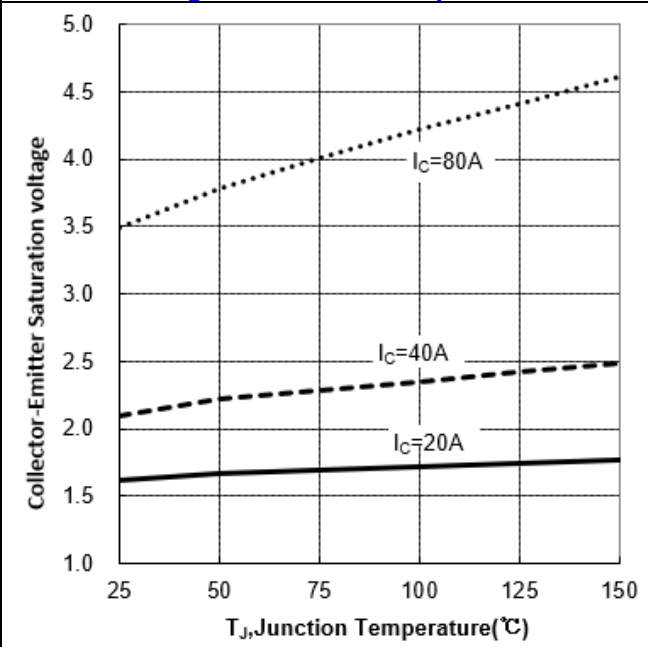


Figure 8. Typical Transfer Characteristics

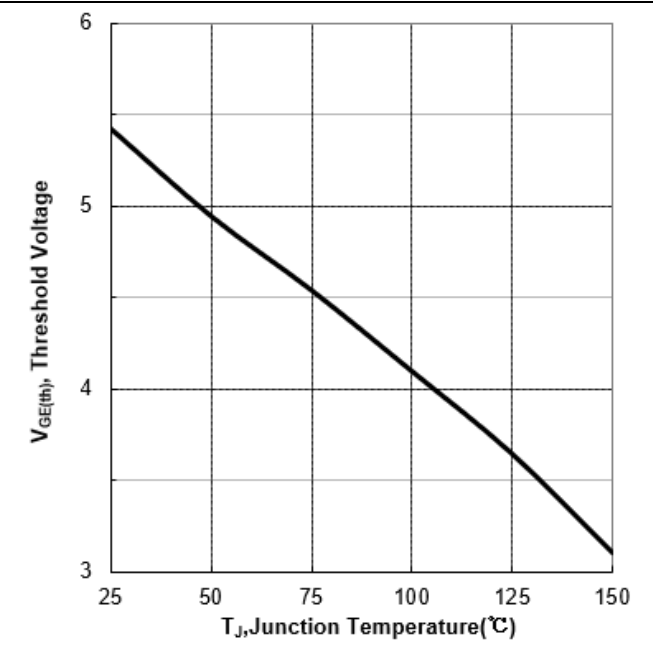


Figure 9. Typical Gate Charge

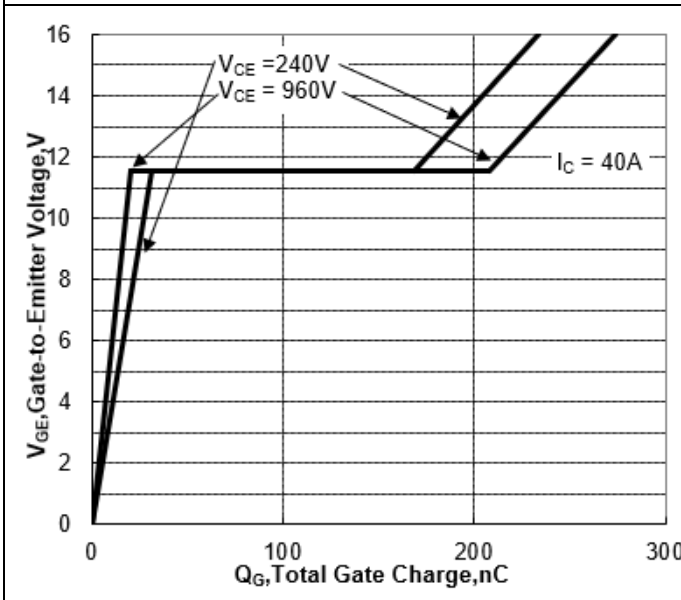


Figure 10. Typical Capacitance vs Collector-Emitter Voltage

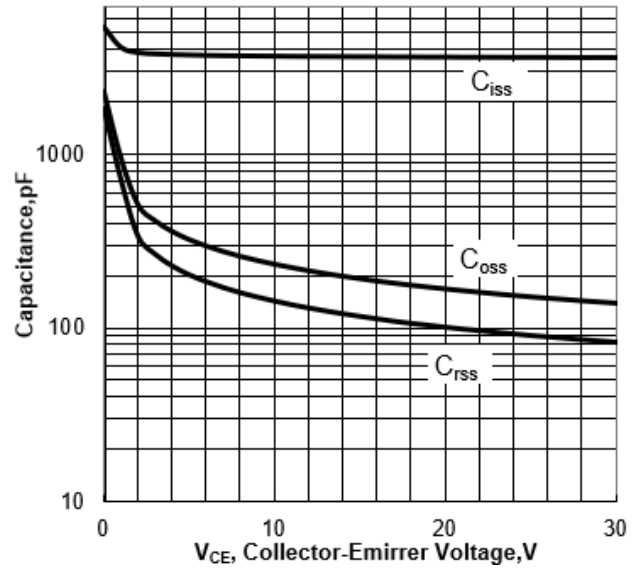


Figure 11. IGBT Transient Thermal Impedance vs Pulse Width

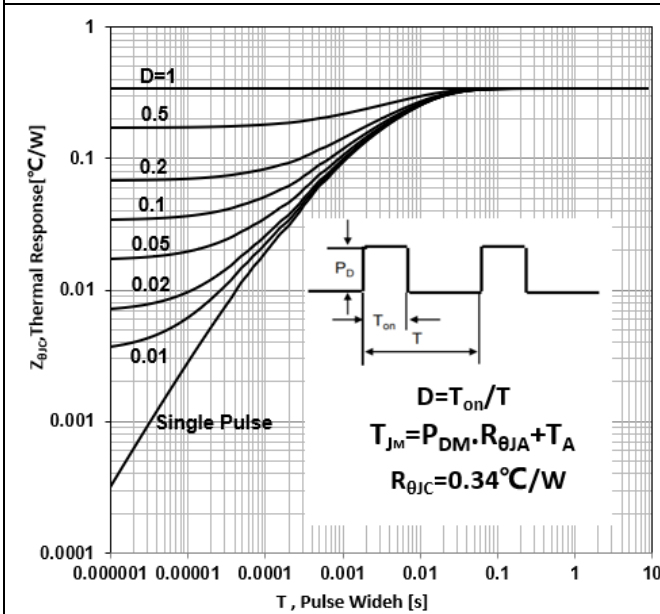


Figure 12. Diode Transient Thermal Impedance vs Pulse Width

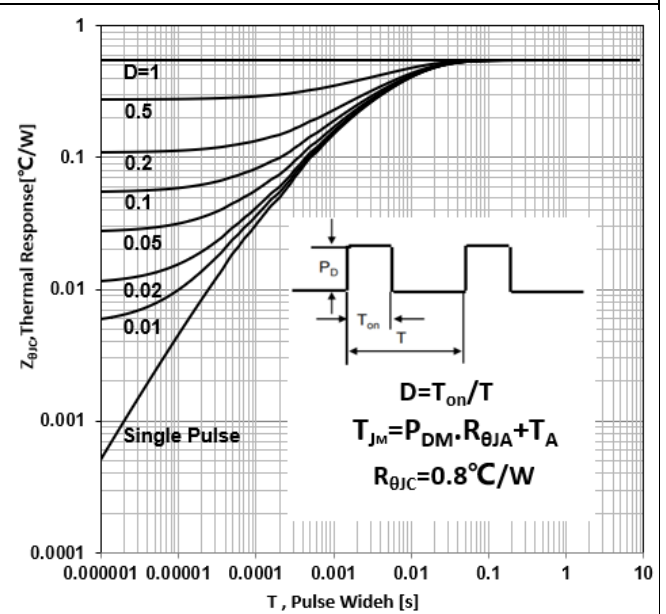
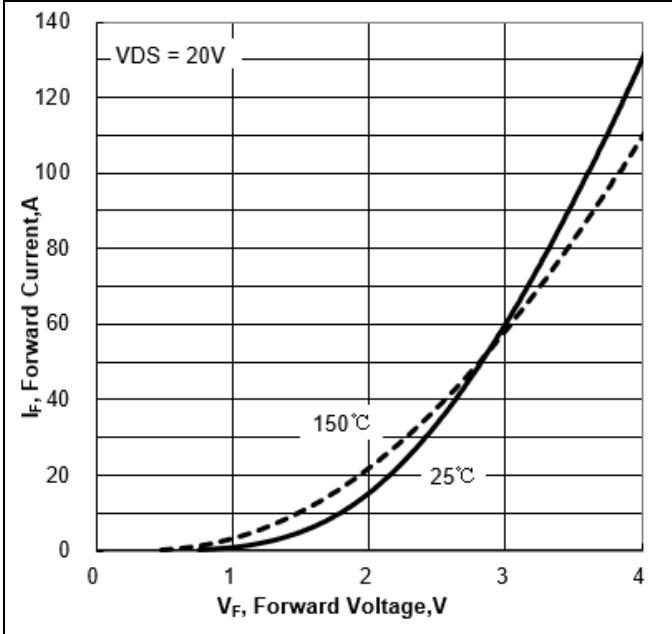
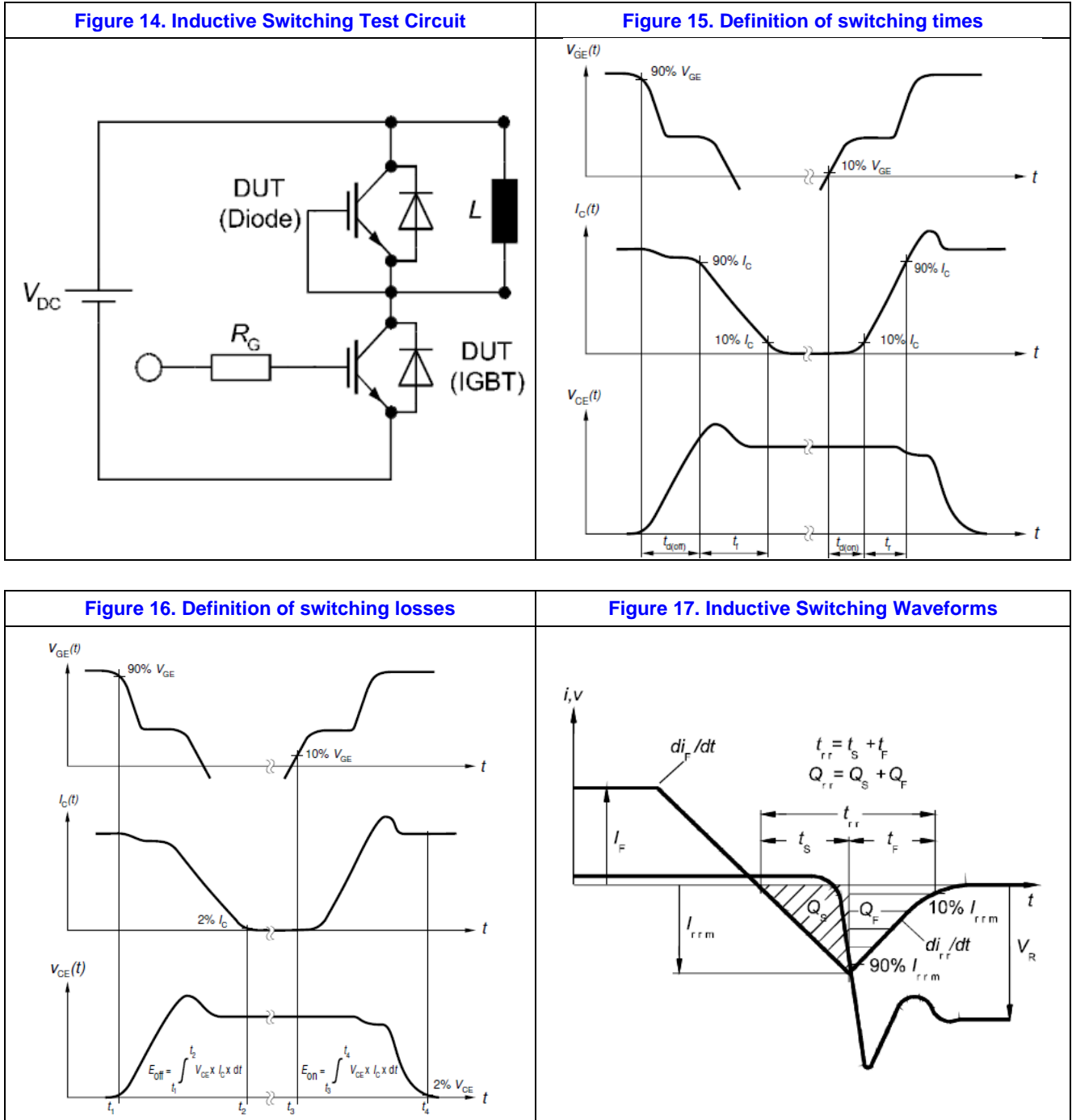


Figure 13. Typical Diode Forward Current vs Forward Voltage

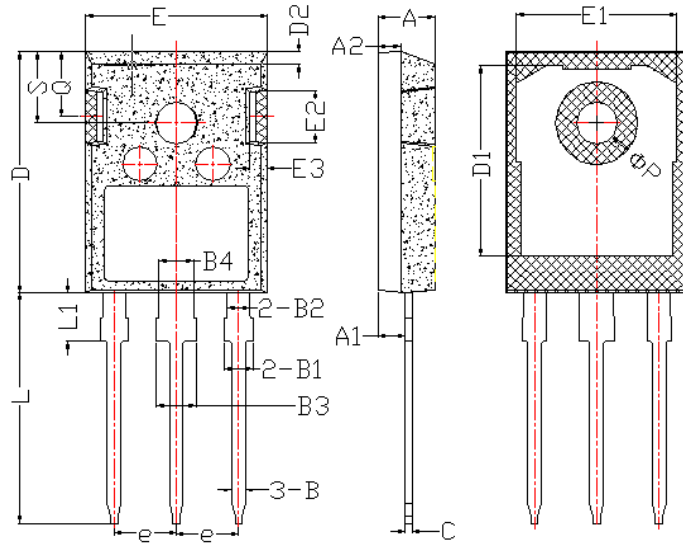


## 6. Test Circuit and Waveform





## 7. Package Description



Items	Values(mm)	
	MIN	MAX
A	4.90	5.16
A1	2.27	2.53
A2	1.85	2.11
B	1.07	1.33
B1	1.90	2.41
B2	1.75	2.15
B3	2.87	3.38
B4	2.87	3.13
C	0.55	0.68
D	20.82	21.10
D1	16.25	17.65
D2	1.05	1.35
E	15.70	16.03
E1	13.10	14.15
E2	3.68	5.10
E3	1.68	2.60
e	5.44	
L	19.80	20.31
L1	4.17	4.47
ΦP	3.50	3.70
Q	5.49	6.00
S	6.04	6.30

TO-247 Package

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